Product Specification

200G QSFP56 to 2x100G QSFP56
Breakout Active Optical Cable

P/N: HDR-Q56-2Q-A

Features

- Supporting 200Gbps to 2x100Gbps
- Available length range 1m~100m
- Active Optical Cable
- Operating data rate 212.5Gbps
- Single +3.3V power supply
- Max power dissipation <4.5W
- VCSEL Array Transmitter and PIN Array Receiver
- High-Density QSFP56 38-PIN and 4x SFP56 20-PIN Connector
- 4-Channel Full-Duplex Active Optical Cable
- Commercial temperature range 0°C to 70°C

Compliance

- Compliant with SFP56 MSA
- Compliant with Electrical MSA SFF-8636
- Compliant with Mechanical MSA SFF-8665
- IEEE 802.3bj
- RoHS

Applications

- Supports InfiniBand HDR/EDR Systems
- Switches, servers,routers and HBA
- Data center cabling infrastructure
- High speed multi-channel parallel data connections

Description

The HDR-Q56-2Q-A is an breakout active optical cable (AOC) designed to support InfiniBand HDR 200G on one end, with two 100G EDR 100G connections on the other. Featuring QSFP56 connectors, this cable enables the efficient bifurcation of a single 200G link into two 100G connections, making it a versatile solution for high-performance data transmission in demanding environments such as data centers and supercomputing applications.

The HDR-Q56-2Q-A cable is ideal for applications where multiple lower-bandwidth connections are required from a single high-bandwidth source. It ensures high-speed, low-latency data transfer while maintaining excellent signal integrity, making it suitable for high-performance computing, artificial intelligence, and large-scale cloud infrastructure. Its AOC design reduces power consumption and supports long-distance transmission, while the passive nature of the cable ensures reliable and cost-effective performance in dense, high-bandwidth network configurations.

Product performance Specifications

1. Basic Product Characteristics

Parameter	Symbol	Min	Typ.	Max	Unit
Absolute Maximum Ratings					
Supply voltage	V_{CC}	-0.3	-	3.6	V
Data input voltage		-0.3	-	3.465	V
Control input voltage	V_I	-0.3	-	4.0	V
Damage threshold		3.4	-	-	dBm
Storage temperature	T_S	-40	-	85	°C
Operational Specifications					
Supply Voltage	V_{CC}	3.135	-	3.465	V
Power dissipation (200G re-timing on all lanes)		-	4.35	4.55	W
Power dissipation (100G re-timing on all lanes)		-	2.5	2.75	W
Supply noise tolerance (10Hz-10MHz)		66	-	-	mVpp
Operating case temperature	T_{OC}	0	-	70	°C
Operating relative humidity	RH	5	-	85	%

2. Product Optical and Electrical Characteristics

Parameter	Symbol	Min	Typ.	Max	Unit	Note
Transmitter						
Signaling Speed per Lane		PRBS31Q@26.5625Gbd PAM4			Gb/s	
Differential Input Impedance	Z_{IN}	90	100	110	Ω	
Center Wavelength	C	840	850	860	nm	
Differential Input Voltage	V_{IN}	-	900	-	mVpp	
Differential termination mismatch				10	%	
DC common mode voltage		350		2850	mV	
Receiver						
Signaling Speed per Lane		PRBS31Q@26.5625Gbd PAM4			Gb/s	
Center Wavelength	C	840	850	860	nm	
Differential Input Impedance				10	%	
Differential Input Voltage	Zout	90	100	110	Ω	
Differential termination mismatch	Vout			900	mVpp	
DC common mode voltage		-350		2850	mV	
Error Bit Rate	BER			2.4E-4		

Note1: PRBS31Q@26.5625Gbd PAM4

Recommended Host Board Power Supply Circuit

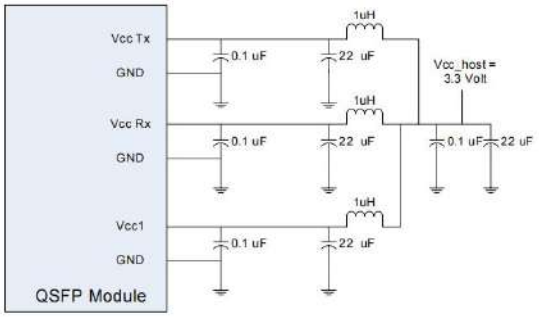


Figure 1: Recommended Host Board Power Supply Circuit

Recommended Interface Circuit

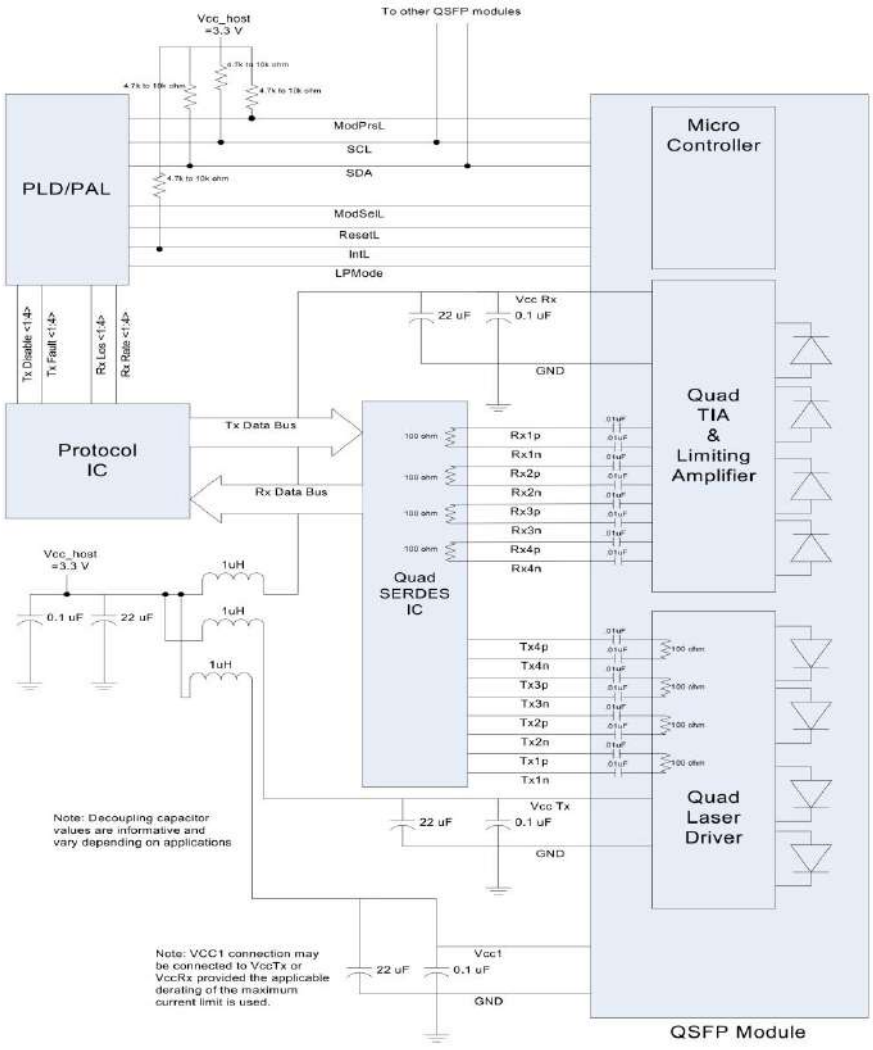


Figure2: Recommended Interface Circuit

Pin-out Definition

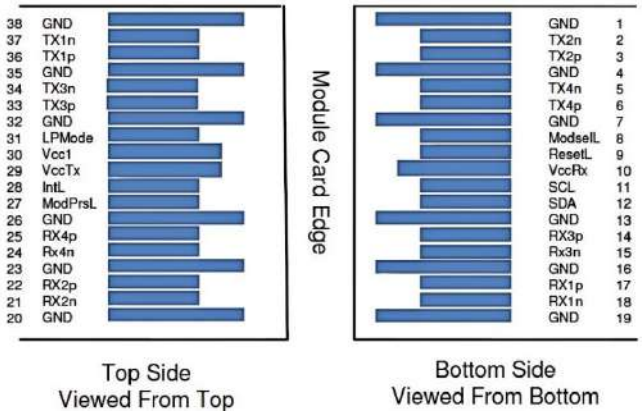


Figure3: Pin view

Pin Function Definitions

Pin	Logic	Symbol	Description	Note
1		GND	Ground	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	3
4		GND	Ground	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	3
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	3
7		GND	Ground	1
8	LVTTL-I	ModSelL	Module Select	4
9	LVTTL-I	ReSelL	Module Select	4
10		Vcc Rx	+3.3V Power Supply Receiver	2
11	LVCMOS-I/O	SCL	2-wire serial interface clock	4
12	LVCMOS-I/O	SDA	2-wire serial interface data	4
13		GND	Ground	1
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	3
15	CML-O	Rx3n	Receiver Inverted Data Output	3
16		GND	Ground	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3
18	CML-O	Rx1n	Receiver Inverted Data Output	3
19		GND	Ground	1
20		GND	Ground	1
21	CML-O	Rx2n	Receiver Inverted Data Output	3
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3
23		GND	Ground	1
24	CML-O	Rx4n	Receiver Inverted Data Output	3

25	CML-O	Rx4p	Receiver Non-Inverted Data Output Ground	3
26		GND	Ground	1
27	LVTTL-O	ModPrsL	Module Present	4
28	LVTTL-O	IntL	Interrupt	4
29		Vcc Tx	+3.3V Power supply transmitter	2
30		Vcc1	+3.3V Power supply	2
31	LVTTL-I	LPMode	Low Power Mode	4
32		GND	Ground	1
33	CML-I	Tx3p	Transmitter Non-Inverted Data Input	3
34	CML-I	Tx3n	Transmitter Inverted Data Input	3
35		GND	Ground	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3
37	CML-I	Tx1n	Transmitter Inverted Data Input	3
38		GND	Ground	1

Note1: GND is the symbol for signal and supply (power) common for the QSFP+ module. All are common within the QSFP+ module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

Note2: Vcc Rx, Vcc1 and Vcc Tx are the receiver and transmitter power supplies and shall be applied concurrently. Requirements defined for the host side of the Host Edge Card Connector are listed in Table. Recommended host board power supply filtering is shown in Host board power supply circuit. Vcc Rx Vcc1 and Vcc Tx may be internally connected within the QSFP module in any combination. The connector pins are each rated for a maximum current of 500 mA.

Note3: High-speed signal interfaces require differential pairs (e.g. TX1+/TX1-) with tightly matched impedances (typically 100Ω).

Note4: The management and control signals are based on LVTTL level logic and are used for functions such as module selection and reset.

Monitoring Specification

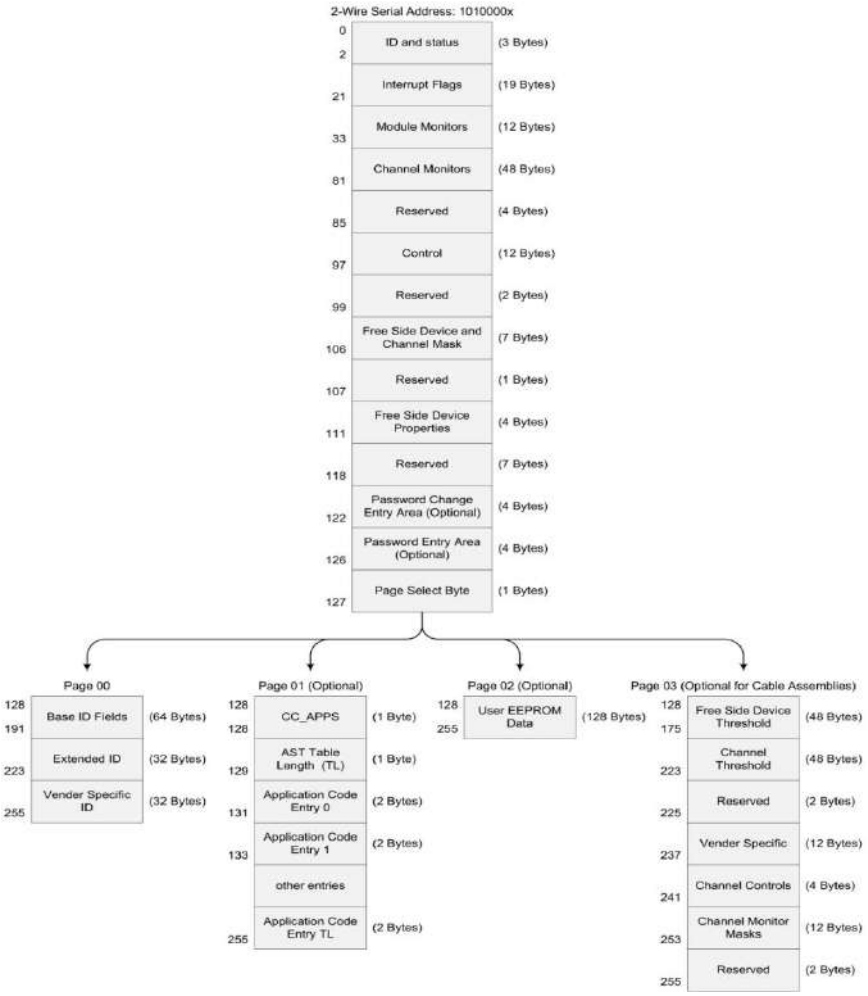


Figure4:QSFP Memory map

Memory map Table

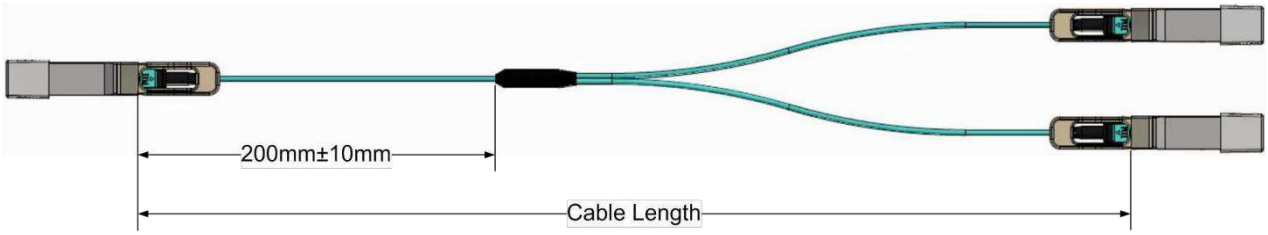
Byte	Unit	Name	Description
Lower Page 00h			
0	1	Identifier	Type of transceiver,Page 00h Byte 0 and Page 00h Byte 128 shall contain the same parameter values.
1	1	Status	Revision Compliance
2	1	Status	Status indicators
3-21	19	Interrupt Flags	Consist of interrupt flags for LOS, Tx Fault, warnings and alarms. The non-asserted state shall be 0b.
22	1	Temperature MSB	Internally measured temperature (MSB)
23	1	Temperature LSB	Internally measured temperature (LSB)
24-25	2	Reserved	Reserved

26	1	Supply Voltage MSB	Internally measured supply voltage (MSB)
27	1	Supply Voltage LSB	Internally measured supply voltage (LSB)
28-29	2	Reserved	Reserved
30-33	4	Vendor Specific	Vendor Specific
34	1	Rx1 Power MSB	Internally measured Rx1 input power
35	1	Rx1 Power LSB	
36	1	Rx2 Power MSB	Internally measured Rx2 input power
37	1	Rx2 Power LSB	
38	1	Rx3 Power MSB	Internally measured Rx3 input power
39	1	Rx3 Power LSB	
40	1	Rx4 Power MSB	Internally measured Rx4 input power
41	1	Rx4 Power LSB	
42	1	Tx1 Bias MSB	Internally measured Tx1 bias
43	1	Tx1 Bias LSB	
44	1	Tx2 Bias MSB	Internally measured Tx2 bias
45	1	Tx2 Bias LSB	
46	1	Tx3 Bias MSB	Internally measured Tx3 bias
47	1	Tx3 Bias LSB	
48	1	Tx4 Bias MSB	Internally measured Tx4 bias
49	1	Tx4 Bias LSB	
50	1	Tx1 Power MSB	Internally measured Tx1 Power
51	1	Tx1 Power LSB	
52	1	Tx2 Power MSB	Internally measured Tx2 Power
53	1	Tx2 Power LSB	
54	1	Tx3 Power MSB	Internally measured Tx3 Power
55	1	Tx3 Power LSB	
56	1	Tx4 Power MSB	Internally measured Tx4 Power
57	1	Tx4 Power LSB	
58-65	8	Reserved	Reserved channel monitor set 4
66-73	8	Reserved	Reserved channel monitor set 5
74-81	8	Vendor Specific	Vendor Specific
82-85	4	Reserved	Reserved
86-99	14	Control	Control
100-106	7	Free Side Device and Channel Masks	Free Side Device and Channel Masks
107-110	4	Free Side Device Properties	Free Side Device Properties
111-112	2	Assigned for use by PCI Express	Used for: - The PCI Express External Cable Specification - The PCI Express OCuLink Specification
113-117	4	Free Side Device Properties	Free Side Device Properties
118	1	Reserved	Reserved
119-122	4	Password Change Entry Area	Password Change Entry Area

123-126	4	Password Entry Area	Password Entry Area
127	1	Page Select Byte	Page Select Byte
Upper Page 00h			
128	1	Identifier	Identifier Type of free side device.(See SFF-8024 Transceiver Management)
129	1	Ext. Identifier	Extended Identifier of free side device. Includes power classes, CLEI codes, CDR capability.
130	1	Connector Type	Code for media connector type. (See SFF-8024 Transceiver Management)
131-138	8	Specification Compliance	Code for electronic or optical compatibility.
139	1	Encoding	Code for serial encoding algorithm. (See SFF-8024 Transceiver Management)
140	1	Signaling rate, nominal	Nominal signaling rate, units of 100 MBd. For rate > 25.4 GBd, set this to FFh and use Byte 222.
141	1	Extended Rate Select Compliance	Tags for extended rate select compliance.
142	1	Length (SMF)	Link length supported at the signaling rate in byte 140 or page 00h byte 222, for SMF fiber in km *. A value of 1 shall be used for reaches from 0 to 1 km.
143	1	Length (OM3 50 um)	Link length supported at the signaling rate in byte 140 or page 00h byte 222, for EBW 50/125 um fiber (OM3), units of 2 m *
144	1	Length (OM2 50 um)	Link length supported at the signaling rate in byte 140 or page 00h byte 222, for 50/125 um fiber (OM2), units of 1 m *
145	1	Length (OM1 62.5 um) or Copper Cable Attenuation	Link length supported at the signaling rate in byte 140 or page 00h byte 222, for 62.5/125 um fiber (OM1), units of 1 m *, or copper cable attenuation in dB at 25.78 GHz.
146	1	Length (passive copper or active cable or OM4 50 um)	Length of passive or active cable assembly (units of 1 m) or link length supported at the signaling rate in byte 140 or page 00h byte 222, for OM4 50/125 um fiber (units of 2 m) as indicated by Byte 147. See 6.3.12.
147	1	Device technology	Device technology
148-163	16	Vendor name	Free side device vendor name (ASCII)
164	1	Extended Module	Extended Module codes for InfiniBand.
165-167	3	Vendor OUI	Free side device vendor IEEE company ID.
168-183	16	Vendor PN	Part number provided by free side device vendor(ASCII)
184-185	2	Vendor rev	Revision level for part number provided by the vendor(ASCII)
186-187	2	Wavelength or Copper Cable Attenuation	Nominal laser wavelength (wavelength=value/20 in nm) or copper cable attenuation in dB at 2.5 GHz (Byte 186) and 5.0 GHz (Byte 187)
188-189	2	Wavelength tolerance or Copper Cable Attenuation	The range of laser wavelength (+/- value) from nominal wavelength. (wavelength Tol. =value/200 in nm) or copper cable attenuation in dB at 7.0 GHz (Byte 188) and 12.9 GHz (Byte 189)
190	1	Max case temp	Maximum case temperature

191	1	CC_BASE	Check code for base ID fields (Bytes 128-190)
192	1	Link codes	Extended Specification Compliance Codes (See SFF-8024)
193-195	3	Options	Optional features implemented.
196-211	16	Vendor SN	Serial number provided by vendor.(ASCII)
212-219	8	Date Code	Vendor's manufacturing date code.
220	1	Diagnostic Monitoring Type	Indicates which type of diagnostic monitoring is implemented (if any) in the free side device. Bit 1,0 Reserved.
221	1	Enhanced Options	Indicates which optional enhanced features are implemented in the free side device.
222	1	CC_EXT	Check code for the Extended ID Fields (Bytes 192-222)
224-255	32	Vendor Specific	Vendor Specific EEPROM

Mechanical Dimension



Note：

- Diameter: 3mm
- Minimum bend radius:30mm
- Cable color:Orange(OM2),Aqua(OM3),Magenta(OM4)
- When L≤1m, the tolerance is +5cm
- When 1m≤L≤4.5m, the tolerance is +15cm
- When 5m≤L≤14.5m, the tolerance is +30cm
- When L≥15m, the tolerance is +2%m

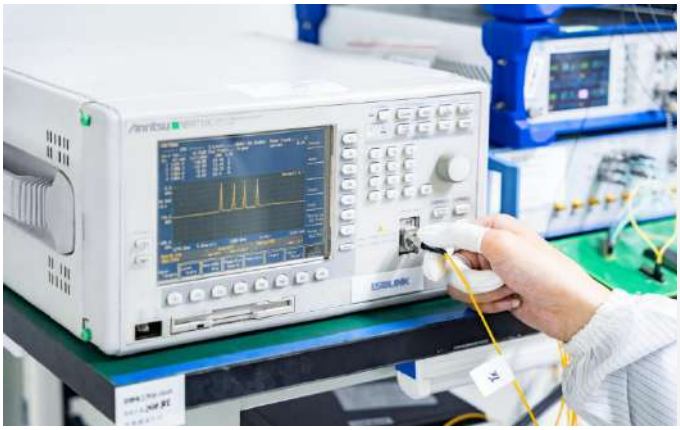
Waring：

- The transceiver optics is supplied with a dust cover. This plug protects the transceiver optics during standard manufacturing processes by preventing contamination from air borne particles.It is recommended that the dust cover remain in the transceiver whenever an optical fiber connector is not inserted.
- Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.
- Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

Test Center

1. Performance Testing

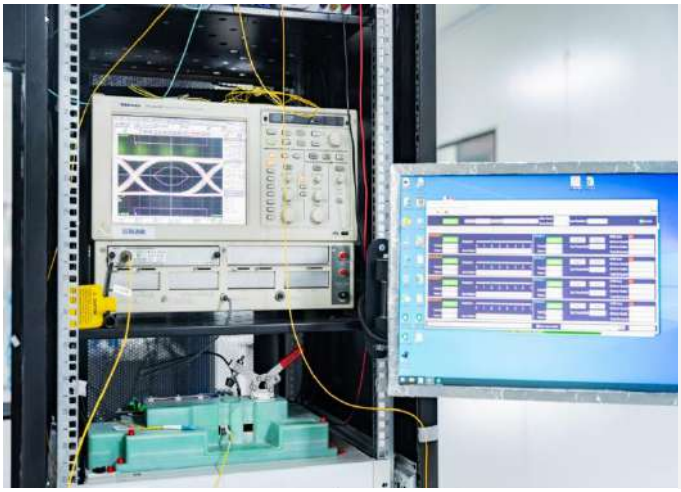
Every fiber optic transceiver is thoroughly tested by the LSOLINK Assurance Program, which is equipped with the world's most advanced analytical equipment to ensure that our transceivers meet the industry's international public protocol standards while still functioning flawlessly in your facility.



Optical Spectrum Inspection

Using the industry's leading optical spectrum analyser to check in real time that the parameters of the optical transceiver's laser comply with industry standards.

- **Peak:** Peak wavelength and peak level
- **2nd Peak:** Side-mode wavelength and level
- **Mean WI:** Center wavelength
- **Total Power:** Total power of spectrum
- **SMSR:** Side-Mode Suppression Ratio



Optical Signal Quality Inspection

Using highly efficient sampling oscilloscopes and BERT testers, equipped with an automated test platform to accurately test the signal quality of the transceiver, test records are kept for up to 5 years to ensure the traceability of each transceiver.

- **Eye Mask Margin(NRZ)**
- **TDECQ(PAM4):**transmitter dispersion eye closure
- **OMA:** Optical modulation amplitude
- **BER:** Bit error rate
- **ER:** Extinction Ratio

Flow Pressure Test

Using multi-protocol network traffic analyser with various brands of switches to test the transceiver's ability to transmit at full speed.

- **Bandwidth:** Actual transceiver bandwidth on the port
- **Packet Loss**
- **Packet Errors:**CRC Errors/PCS Errors/Symbol Errors
- **LinkDown Counts**
- **latency**

Aboveis part of our test bed network equipment. For more information, Please click download for optical transceiver performance test report.

2. Quality Control

We adopt advanced quality management solutions. Each transceiver is self-inspected, including:20x microscope inspection, 200x microscope inspection, and QC process inspection.

visual inspection

Microscopic inspection: 20X

Microscopic inspection: 200X

Reliability Verification

Optical endface inspection

OQC Inspection

Order Information

Part Number	Length(m)	Connector Type	Cable Type	Cable Jacket
HDR-Q56-2Q-A1	1	QSFP56 to 2xQSFP56	Active Optical	OFNP
HDR-Q56-2Q-A3	3	QSFP56 to 2xQSFP56	Active Optical	OFNP
HDR-Q56-2Q-A5	5	QSFP56 to 2xQSFP56	Active Optical	OFNP
HDR-Q56-2Q-A7	7	QSFP56 to 2xQSFP56	Active Optical	OFNP
HDR-Q56-2Q-A10	10	QSFP56 to 2xQSFP56	Active Optical	OFNP
HDR-Q56-2Q-A15	15	QSFP56 to 2xQSFP56	Active Optical	OFNP

Further Information

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Email | For Sales@lsolink.com

Disclaimer

1. We are committed to continuous product improvement and feature upgrades, and the contents con t ained in this manual are subject to change without notice.

2. Nothing herein should be construed as constituting an additional warranty.

3. LSOLINK assumes no responsibility for the use or reliability of equipment or software not provided by LSOLINK.